

TE Internal #: 440055-2

PCB Mount Header, Right Angle, Wire-to-Board, 2 Position, 2 mm [.

079 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder,

Signal, Natural

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Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 2.0 mm Headers











PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Right Angle
Connector System: Wire-to-Board

Number of Positions: 2

Number of Rows: 1

All AMP HPI 2.0 mm Headers (183)

Features

Product Type Features

PCB Connector Type	PCB Mount Header
Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Configuration Features	
PCB Mount Orientation	Right Angle
Number of Positions	2

Electrical Characteristics

Number of Rows

Operating Voltage	250 VDC

Body Features



Primary Product Color	Natural
Contact Features	
PCB Contact Termination Area Plating Material Finish	Bright
Mating Square Post Dimension	.5 mm[.02 in]
Contact Shape & Form	Square
Contact Mating Area Length	3.5 mm[.138 in]
Contact Base Material	Brass
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material Finish	Bright
Contact Mating Area Plating Material	Tin (Sn)
Contact Type F	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Tormination Post & Tail Longth	3.4 mm[.134 in]
Termination Post & Tail Length	
	.5 mm[.02 in]
Square Termination Post & Tail Dimension	.5 mm[.02 in] Through Hole - Solder
Square Termination Post & Tail Dimension	
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment	
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention	Through Hole - Solder
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type	Through Hole - Solder Without
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type	Through Hole - Solder Without Kinked Tines
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention Mating Alignment Type PCB Mount Retention	Through Hole - Solder Without Kinked Tines Polarization
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Retention PCB Mount Alignment V PCB Mount Alignment	Through Hole - Solder Without Kinked Tines Polarization With
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Retention V PCB Mount Alignment Connector Mounting Type	Through Hole - Solder Without Kinked Tines Polarization With Without
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Retention V PCB Mount Alignment V Connector Mounting Type	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Muthousing Features	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment W Housing Features Housing Material	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount With
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Retention V PCB Mount Alignment Connector Mounting Type Mating Alignment W Housing Features Housing Material	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount With With
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Centerline (Pitch) Dimensions	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount With With
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Alignment Connector Mounting Type Mating Alignment Housing Features Housing Material Centerline (Pitch) Dimensions Connector Width	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount With Nylon 66 GF 2 mm[.079 in]
Square Termination Post & Tail Dimension Termination Method to PCB Mechanical Attachment Mating Retention PCB Mount Retention Type Mating Alignment Type PCB Mount Retention PCB Mount Alignment Connector Mounting Type Mating Alignment Connector Mounting Type Mating Alignment Connector Mounting Type Mating Alignment Centerline (Pitch) Dimensions Connector Width PCB Thickness (Recommended)	Through Hole - Solder Without Kinked Tines Polarization With Without Board Mount With Nylon 66 GF 2 mm[.079 in] 7.7 mm[.303 in]



Usage Conditions

Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	250
Packaging Method	Bag

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







Customers Also Bought













Documents

Product Drawings
2.0MM,HDR,2POS,R/A

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_440055-2_B3.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_440055-2_B3.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_440055-2_B3.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

PCB Mount Header, Right Angle, Wire-to-Board, 2 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, Natural



Datasheets & Catalog Pages

HPI Connectors QRG

English

Product Specifications

Application Specification

English

Agency Approvals

UL Report

English

UL Report

English

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